



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts,Customers Priority,Honest Operation,and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



PRELIMINARY SPEC



ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

Part Number: APTF1616SEEVGAPBAC

Hyper Red
Green
Blue

Features

- 1.6mmX1.6mm SMT LED, 0.7mm thickness.
- Low power consumption.
- One red, one green and one blue chips in one package.
- Can produce any color in visible spectrum, including white light.
- Package : 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

Description

The Hyper Red source color devices are made with Al-GaN on GaAs substrate Light Emitting Diode.

The Green source color devices are made with InGaN on G-SiC Light Emitting Diode.

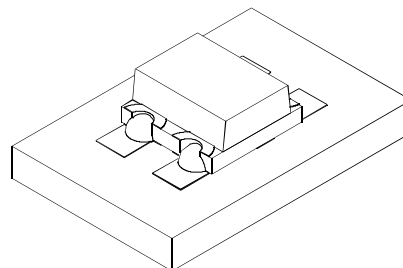
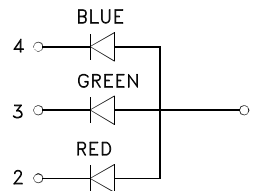
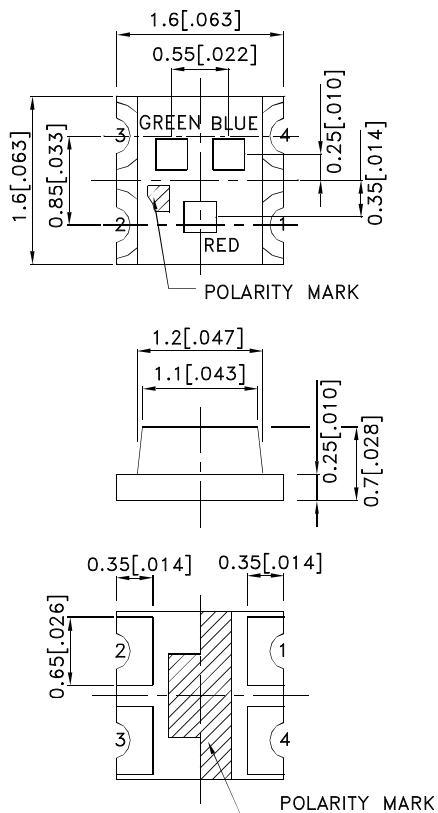
The Blue source color devices are made with InGaN on SiC Light Emitting Diode.

Static electricity and surge damage the LEDs.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

Package Dimensions



Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.2(0.008)$ unless otherwise noted.
3. Specifications are subjected to change without notice.
4. The device has a single mounting surface. The device must be mounted according to the specifications.



Selection Guide

| Part No. | Dice | Lens Type | Iv (mcd) [2] @ 20mA | | Viewing Angle [1] |
|--------------------|---------------------|-------------|------------------------|------|----------------------|
| | | | Min. | Typ. | 2θ1/2 |
| APTF1616SEEVGAPBAC | Hyper Red (AlGaInP) | WATER CLEAR | 180 | 400 | 120° |
| | Green (InGaN) | | 70 | 180 | |
| | Blue (InGaN) | | 10 | 40 | |

Notes:

1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.
2. Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

| Symbol | Parameter | Device | Typ. | Max. | Units | Test Conditions |
|--------------------|--------------------------|----------------------------|-------------------|----------------|-------|---------------------------|
| λ _{peak} | Peak Wavelength | Hyper Red Green Blue | 630 520 468 | | nm | I _F =20mA |
| λ _D [1] | Dominant Wavelength | Hyper Red Green Blue | 621 525 470 | | nm | I _F =20mA |
| Δλ _{1/2} | Spectral Line Half-width | Hyper Red Green Blue | 20 35 21 | | nm | I _F =20mA |
| C | Capacitance | Hyper Red Green Blue | 25 100 100 | | pF | V _F =0V;f=1MHz |
| V _F [2] | Forward Voltage | Hyper Red Green Blue | 2 3.2 3.2 | 2.5 4 4 | V | I _F =20mA |
| I _R | Reverse Current | Hyper Red Green Blue | | 10 10 10 | uA | V _R =5V |

Notes:

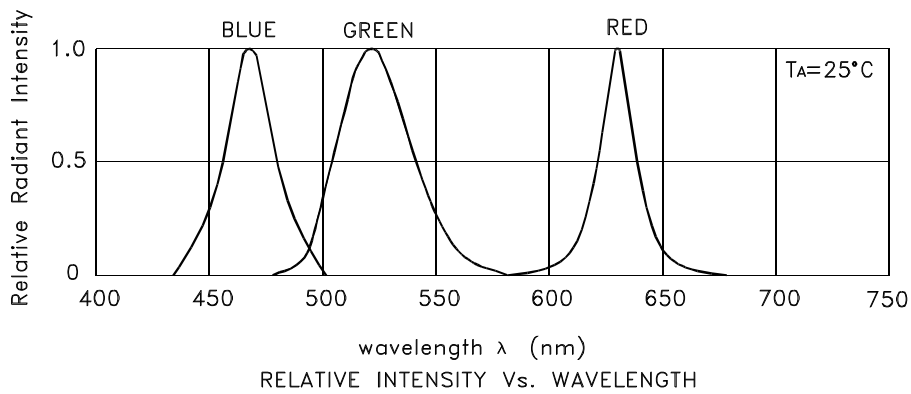
1. Wavelength: +/-1nm.
2. Forward Voltage: +/-0.1V.

Absolute Maximum Ratings at TA=25°C

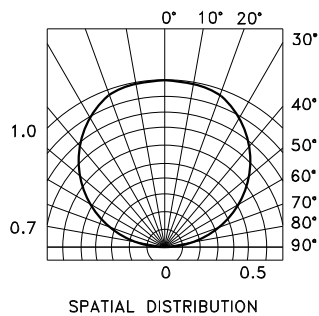
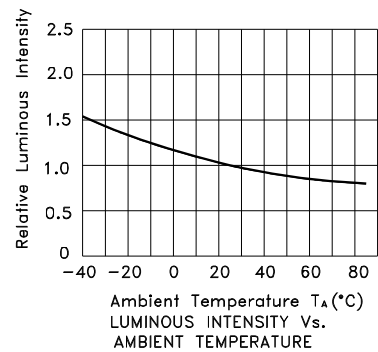
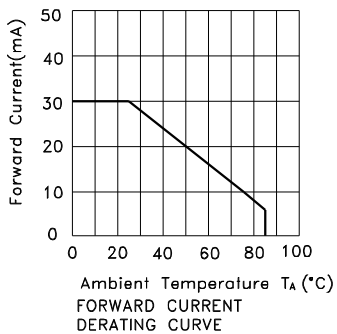
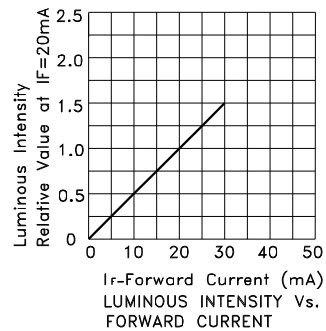
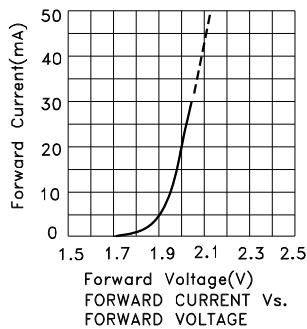
| Parameter | Hyper Red | Green | Blue | Units |
|--------------------------|----------------|-------|------|-------|
| Power dissipation | 75 | 120 | 120 | mW |
| DC Forward Current | 30 | 30 | 30 | mA |
| Peak Forward Current [1] | 195 | 100 | 100 | mA |
| Reverse Voltage | 5 | | | V |
| Operating Temperature | -40°C To +85°C | | | |
| Storage Temperature | -40°C To +85°C | | | |

Notes:

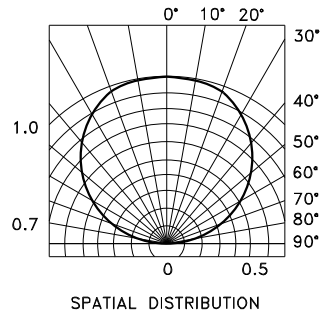
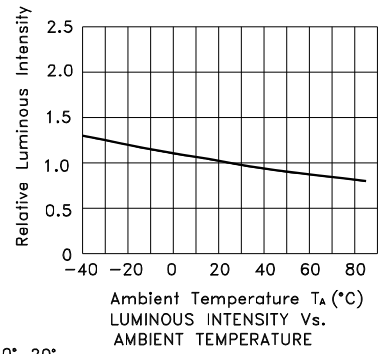
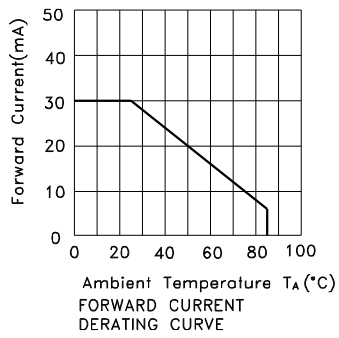
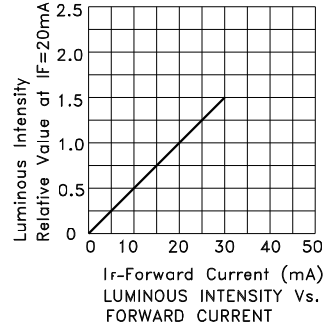
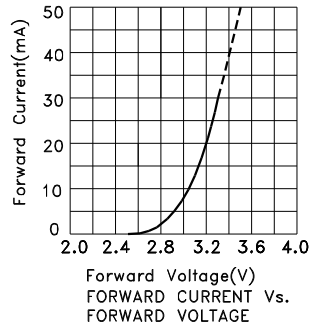
1. 1/10 Duty Cycle, 0.1ms Pulse Width.



APTF1616SEEVGAPBAC Hyper Red

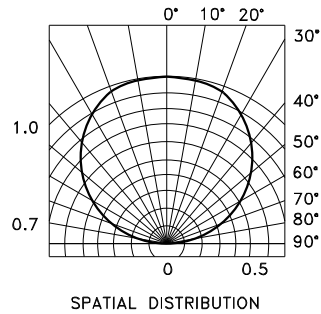
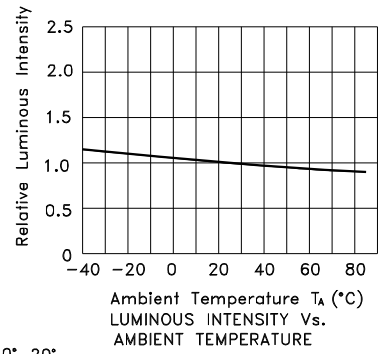
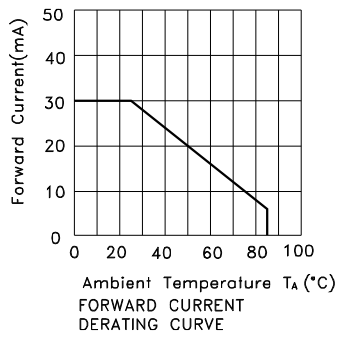
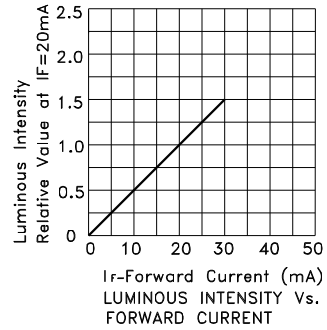
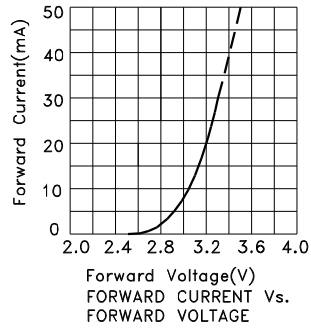


Green



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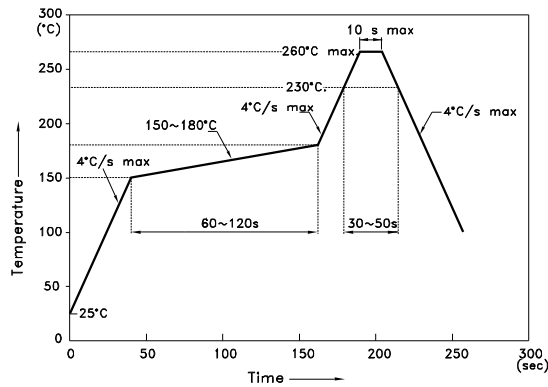
Blue



APTF1616SEEVGAPBAC

Reflow soldering is recommended and the soldering profile is shown below.
Other soldering methods are not recommended as they might cause damage to the product.

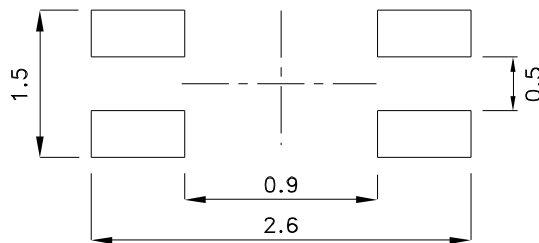
Reflow Soldering Profile For Lead-free SMT Process.



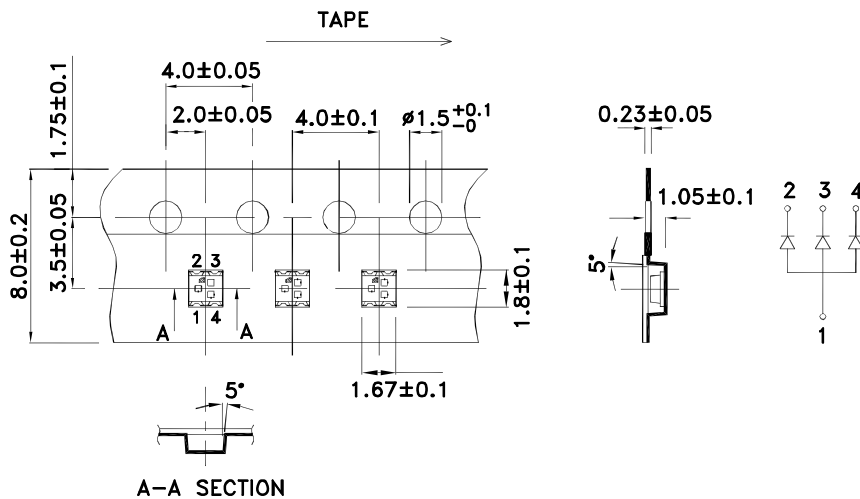
NOTES:

1. We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)



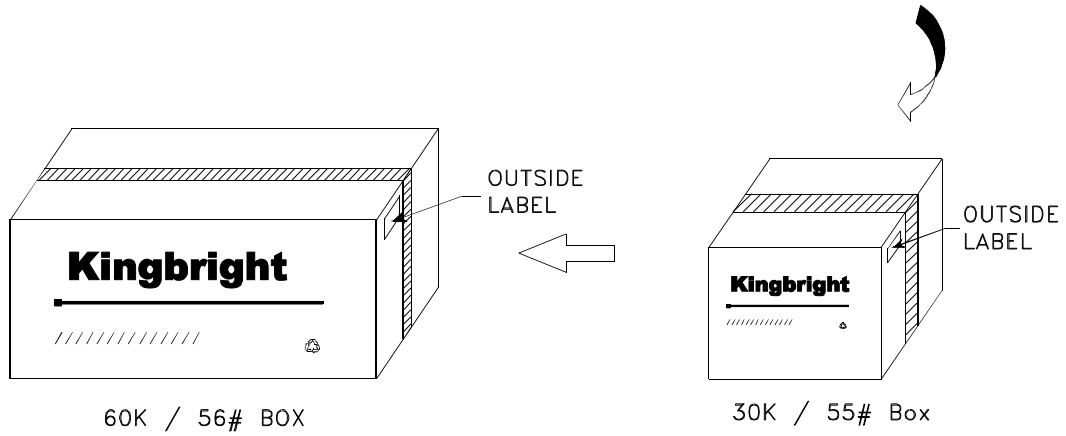
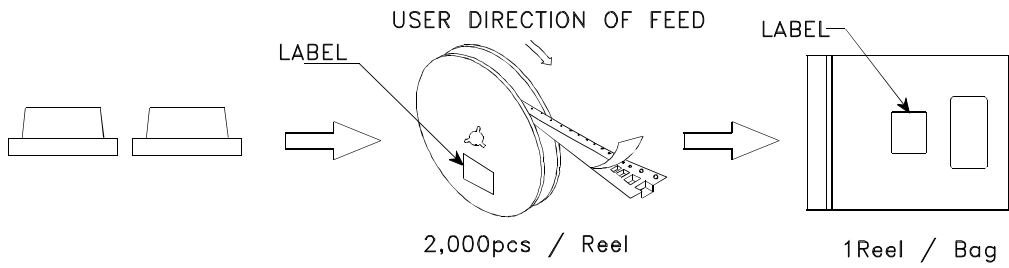
Tape Dimensions (Units : mm)




Kingbright

PACKING & LABEL SPECIFICATIONS

APTF1616SEEVGAPBAC



| | |
|---|--|
| Kingbright | |
| P/NO: APTF1616xxx | |
| QTY: 2,000 pcs | Q.C. Q C xx xx xxxx PASSED |
| S/N: XXXX | |
| CODE: XXX | |
| LOT NO: | |
|  xxxxxxxxxxxxxxxxxxxxxxxx | |
| RoHS Compliant | |